FAX NO.

| |5

Customer No.: 31561 Application No.: 10/709,990 Docket No.: 11416-US-PA

## **AMENDMENTS**

## To the Claims,

Please amend the claims according to the following listing of claims and substitute it for all prior versions and listing of claims in the application.

1. (currently amended) A solder composition, comprising:

chromium (Cr) in an amount of 5~20 wt.%;

stibium (Sb) in an amount of 0.0111~50 wt.%;

a component selected from the group consisting of tin (Sn), zinc (Zn), bismuth (Bi), indium (In) and a mixture thereof;

another component selected from the IIIB group in the periodic table or a mixture thereof in an amount of 0.019~20 wt.%; and

an impurity.

- 2. (previously presented) The solder composition according to claim 1, further comprising another component selected from the IVB group in the periodic table or a mixture thereof in an amount of 0.01~10 wt.%.
- 3. (previously presented) The solder composition according to claim 1, further comprising another component selected from the VB group in the periodic table or a mixture thereof in an amount of 0.01~10 wt.%.

BEST AVAILABLE COPY

Customer No.: 31561 Application No.: 10/709,990 Docket No.: 11416-US-PA

4. (cancelled)

5. (previously presented) The solder composition according to claim 1, wherein the

component selected from the IIIB group in the periodic table or a mixture thereof at least

comprises cerium (Ce), samarium (Sm), neodymium (Nd), lutetium (Lu) or a mixture thereof.

6. (original) The solder composition according to claim 1, further comprising another

component selected from silver (Ag), copper (Cu) or a mixture thereof having an amount of

0.01~10 wt.%.

7. (cancelled).

8. (original) The solder composition according to claim 1, further comprising another

component selected from nickel (Ni), cobalt (Co), manganese (Mn) or a mixture thereof in an

amount of 0.01~5 wt.%.

9. (original) The solder composition according to claim 1, further comprising gallium

(Ga) in an amount of 0.01~10 wt.%.

Claims 10-14 (cancelled)

Page 3